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APPLICA	BL	E STANI	DARD									
Operating						Sto	orage			_		
	Те	mperature R	ange	-55 °C to 105	°C (1)	Те	mperatur	ure Range umidity Range		-10 °C to 60 °C	(2)	
RATING	Vo	ltage		600 V AC/D		Sto	orage Hu			40 % to 70 9	% (2)	
	Cu	ırrent	15A			Operating Humidity Range			Range	Relative Humidity 85% max (Not dewed)		
				SPEC	IFICA	ADITA	IS					
IT	ΕN	1	TEST METHOD				REQUIREMENTS				QT	АТ
CONSTRU			TEST METHOD								α.	7
General Examination			Visually and by measuring instrument.				Accord	ing to dr	awing		×	×
Marking			Confirmed visually.				1, 10001.4	ing to ai	aming.		×	×
ELECTRIC CHARACT			1				<u> </u>					
Contact Resistance							2 mΩ N	ЛАХ			×	_
Insulation Resistance			1000 V DC.				1000 MΩ MIN.				×	_
Voltage Proof			1800 V AC for 1 min.				No flashover or breakdown.				×	_
MECHANI	CA	L CHAR	ACTERISTICS									
Insertion and			Measured by applicable connector.				Insertion Force: 10 N MAX.				×	_
Withdrawal Forces							Withdrawal Force: 0.4 N MIN.					
Mechanical Operation			100 times insertions and extractions.				① Contact Resistance: 5 m Ω MAX.				×	_
							② No damage, crack and looseness of parts.					
Vibration Shock			Frequency 10 to 55 to 10Hz, approx 5min					① No electrical discontinuity of 1 μs.				-
			Single amplitude : 0.75 mm, 10 cycles				2 No	damage	, crack	and looseness of parts.		
			for 3 axial directions. 490 m/s², duration of pulse 11 ms,				┨				×	
			3 times to both directions in 3 axial directions.									
ENVIRON	ME	NTAL C	HARAC	TERISTICS			1					
Damp Heat				at 40±2 °C, 90 ~ 95 %,	96 ±4h	າ.	① Cor	ntact Res	sistanc	e: 5mΩ MAX.	×	_
(Steady State)							② Insulation Resistance: 1000 M Ω MIN.					
Rapid Change of			Temperature -55 → +105 °C				③ No damage, crack and looseness of parts.				×	_
Temperature			Time 30 → 30 min.									
			under 5 cycles.									
Dayboot			(Relocation time to chamber: within 2~3 MIN)				-					
Dry heat			Exposed at +105±2°C for 96±4h.								×	
Cold			Exposed at -55±2°C for 96±4h.								×	_
Sulfur Dioxide	<u> </u>		Exposed :	 at 25±2℃, 75±5%RH,			① Cor	ntact Res	sistanc	e: 5mΩ MAX.	×	_
2.03,00		25 PPM for 96h±4h.			② No defect such as corrosion which impairs the function of connector.							
Resistance to			Solder bath : Solder temperature 260±5°C				No deformation of case of excessive looseness				×	_
Soldering Heat			for immersion, duration 10±1sec.				of the t	erminal.				
			Soldering	irons: 380°C MAX. for 10 se	ec.							
Solderability			Soldered at solder temperature 240±3°C for immersion, duration 3 sec.				A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.				_	
COUN	T	DI	ESCRIPTION	ON OF REVISIONS		DESIC	NED			CHECKED	DA	TE
<i>∕</i> 0∖												
REMARKS	⁽¹⁾ Inc	lude tempera	ture rise cau	re rise caused by current-carrying.				APPROVED		HS. OKAWA	14. 0	9. 12
_			s a long-term storage state roduct before assembly to PCB.					CHECKED DESIGNED		KN. SHIBUYA 14		9. 11
												9. 11
Unless otherwise specified, re				er to JIS-C-5402,IEC60512.			DRA			DK. AIMOTO	14. 09. 11	
Note QT:Qualification Test AT:Ass				<u>`</u>	DRAWI		NG NO.		ELC4-359161-00			
HS			SPECIFICATION SHEET			PART NO.		FX30B-2P-7. 62DSA30				
		HIROSE ELECTRIC CO., LTD.				CODE	E NO.	CL570-		-3304-3-00	<u> </u>	1/1



